查询BFQ17供应商

DATA SHEET

BFQ17
NPN 1 GHz wideband transistor

Product specification
File under Discrete Semiconductors, SC14

September 1995

Philips
Semiconductors

PHILIPS

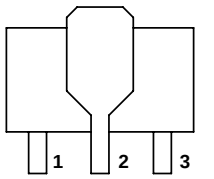
NPN 1 GHz wideband transistor BFQ17

DESCRIPTION

NPN transistor in a SOT89 plastic envelope intended for application in thick and thin-film circuits. The transistor has extremely good intermodulation properties and a high power gain.

PINNING

PIN	DESCRIPTION
Code: FA	
1	emitter
2	collector
3	base



Bottom view MBK514

Fig.1 SOT89.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	40	V
V_{CEO}	collector-emitter voltage	open base	–	25	V
I_{CM}	peak collector current		–	300	mA
P_{tot}	total power dissipation	up to T_s = 145 °C (note 1)	–	1	W
f_T	transition frequency	I_C = 150 mA; V_{CE} = 15 V; f = 500 MHz; T_j = 25 °C	1.5	–	GHz
C_{re}	feedback capacitance	I_C = 10 mA; V_{CE} = 15 V; f = 1 MHz; T_{amb} = 25 °C	1.9	–	pF

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	40	V
V_{CER}	collector-emitter voltage	$R_{BE} \leq 50\ \Omega$	–	40	V
V_{CEO}	collector-emitter voltage	open base	–	25	V
V_{EBO}	emitter-base voltage	open collector	–	2	V
I_C	DC collector current		–	150	mA
I_{CM}	peak collector current	f > 1 MHz	–	300	mA
P_{tot}	total power dissipation	up to T_s = 145 °C (note 1)	–	1	W
T_{stg}	storage temperature		–65	150	°C
T_j	junction temperature		–	175	°C

Note

1. T_s is the temperature at the soldering point of the collector tab.

THERMAL RESISTANCE

SYMBOL	PARAMETER	CONDITIONS	THERMAL RESISTANCE
$R_{th\ j\text{-}s}$	thermal resistance from junction to soldering point	up to T_s = 145 °C (note 1)	30 K/W

Note

1. T_s is the temperature at the soldering point of the collector tab.

CHARACTERISTICS

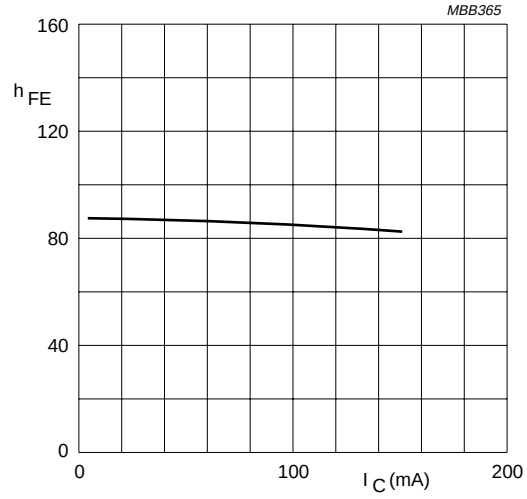
T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CBO}	collector cut-off current	I_E = 0; V_{CB} = 20 V; T_j = 50 °C	–	–	20	μA
$V_{CE\ sat}$	collector-emitter saturation voltage	I_C = 100 mA; I_B = 10 mA	–	–	0.5	V
h_{FE}	DC current gain	I_C = 150 mA; V_{CE} = 5 V	25	80	–	
C_c	collector capacitance	$I_E = i_e$ = 0; V_{CB} = 15 V; f = 1 MHz	–	–	4	pF
C_{re}	feedback capacitance	I_C = 10 mA; V_{CE} = 15 V; f = 1 MHz; T_{amb} = 25 °C	–	1.9	–	pF
f_T	transition frequency	I_C = 150 mA; V_{CE} = 15 V; f = 500 MHz	–	1.5	–	GHz
G_{UM}	maximum unilateral power gain (note 1)	I_C = 60 mA; V_{CE} = 15 V; f = 200 MHz; T_{amb} = 25 °C	–	16	–	dB
		I_C = 60 mA; V_{CE} = 15 V; f = 800 MHz; T_{amb} = 25 °C	–	6.5	–	dB

Note

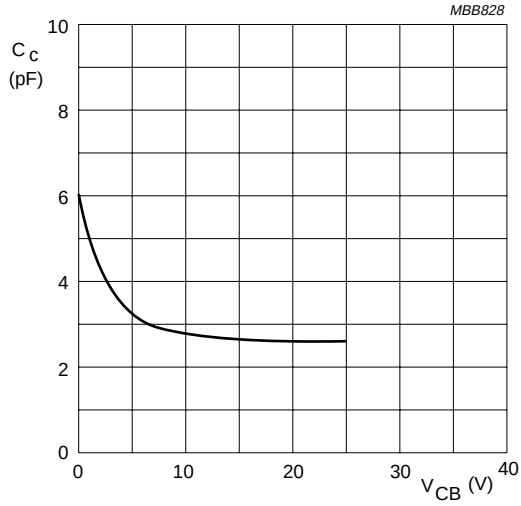
1. G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and

$$G_{UM} = 10 \log \frac{|S_{21}|^2}{\left(1 - |S_{11}|^2\right)\left(1 - |S_{22}|^2\right)} \text{dB}.$$



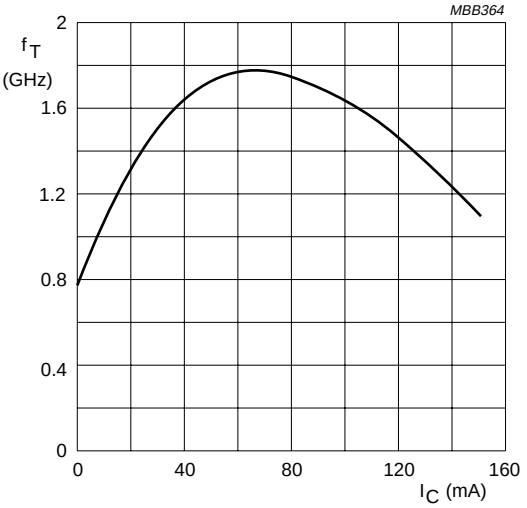
V_{CE} = 5 V; T_j = 25 °C.

Fig.2 DC current gain as a function of collector current.



$I_E = i_e$ = 0; f = 1 MHz; T_j = 25 °C.

Fig.3 Collector capacitance as a function of collector-base voltage.

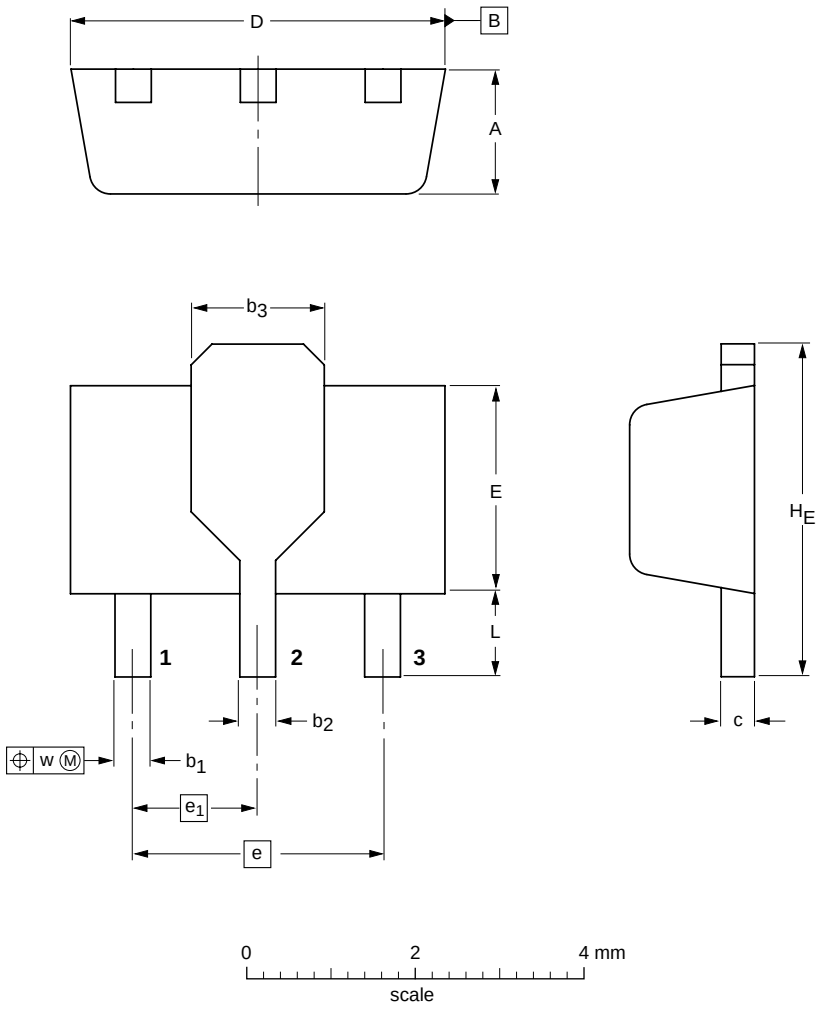


V_{CE} = 15 V; f = 500 MHz; T_j = 25 °C.

Fig.4 Transition frequency as a function of collector current.

PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 3 leads **SOT89**



DIMENSIONS (mm are the original dimensions)

UNIT	A	b_1	b_2	b_3	c	D	E	e	e_1	H_E	L min.	w
mm	1.6 1.4	0.48 0.35	0.53 0.40	1.8 1.4	0.44 0.37	4.6 4.4	2.6 2.4	3.0	1.5	4.25 3.75	0.8	0.13

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT89						97-02-28

DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.